

SEMITRANS® 3

Fast IGBT4 Modules

SKM600GB12T4

Features*

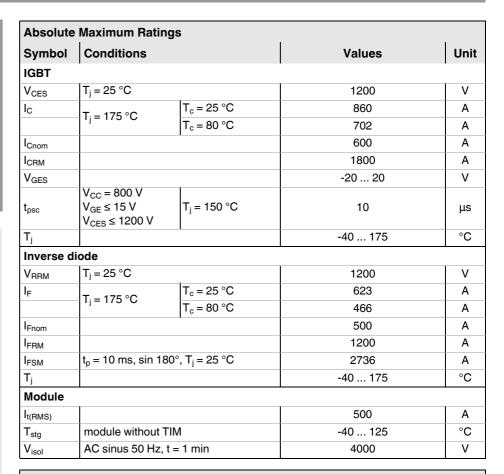
- IGBT4 = 4th generation fast trench IGBT (Infineon)
- CAL4 = Soft switching 4th generation CAL-diode
- · Insulated copper baseplate using DBC technology (Direct Bonded Copper)
- · Increased power cycling capability
- · With integrated gate resistor
- For higher switching frequencies up to 20kHz
- UL recognized, file no. E63532

Typical Applications

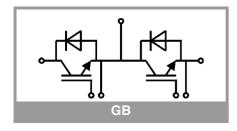
- · AC inverter drives
- UPS
- · Electronic welders at fsw up to 20 kHz

Remarks

- · Case temperature limited to $T_c = 125^{\circ}C$ max.
- Recommended $T_{op} = -40 \dots +150$ °C
- Product reliability results valid for $T_i = 150$ °C



Characteristics									
Symbol	Conditions	min.	typ.	max.	Unit				
IGBT						•			
V _{GE}	$I_{\rm C} = 600 {\rm A}$	T _j = 25 °C		1.80	2.05	V			
	V _{GE} = 15 V chiplevel	T _j = 150 °C		2.20	2.42	V			
V _{CE0}	chiplevel	T _j = 25 °C		0.80	0.90	V			
		T _j = 150 °C		0.70	0.80	V			
r _{CE}	V _{GE} = 15 V chiplevel	T _j = 25 °C		1.67	1.92	mΩ			
		T _j = 150 °C		2.5	2.7	mΩ			
$V_{GE(th)}$	V _{GE} =V _{CE} , I _C = 24 mA		5	5.8	6.5	V			
I _{CES}	$V_{GE} = 0 \text{ V}, V_{CE} = 1200 \text{ V}, T_j = 25 ^{\circ}\text{C}$				5	mA			
C _{ies}	V 05.V	f = 1 MHz		37.2		nF			
Coes	V _{CE} = 25 V V _{GE} = 0 V	f = 1 MHz		2.32		nF			
C _{res}		f = 1 MHz		2.04		nF			
Q_{G}	V _{GE} = - 8 V+ 15 V			3400		nC			
R _{Gint}	T _j = 25 °C			1.3		Ω			
t _{d(on)}	$\begin{array}{c} V_{CC} = 600 \text{ V} \\ I_{C} = 600 \text{ A} \\ V_{GE} = +15/-15 \text{ V} \\ R_{G \text{ on}} = 1.6 \Omega \\ R_{G \text{ off}} = 1 \Omega \\ \text{di/dt}_{on} = 8900 \text{ A/}\mu\text{s} \\ \text{di/dt}_{off} = 4300 \text{ A/}\mu\text{s} \\ \text{dv/dt} = 3550 \text{ V/}\mu\text{s} \\ L_{s} = 24 \text{ nH} \end{array}$	T _j = 150 °C		178		ns			
t _r		T _j = 150 °C		68		ns			
Eon		T _j = 150 °C		33		mJ			
t _{d(off)}		T _j = 150 °C		523		ns			
t _f		T _j = 150 °C		116		ns			
E _{off}		T _j = 150 °C		70		mJ			
R _{th(j-c)}	per IGBT				0.049	K/W			
R _{th(c-s)}	per IGBT (λ _{grease} =0.81 W/(m*K))			0.032		K/W			
R _{th(c-s)}	per IGBT, pre-appli material		0.016		K/W				





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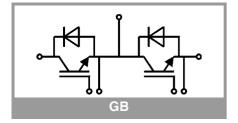
Typical Applications

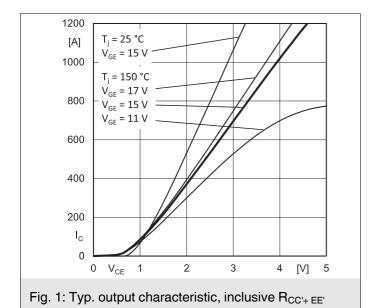
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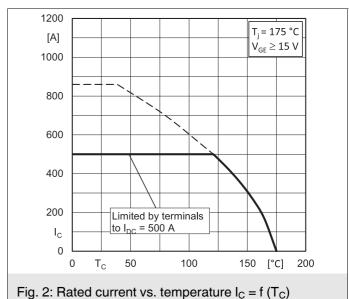
Remarks

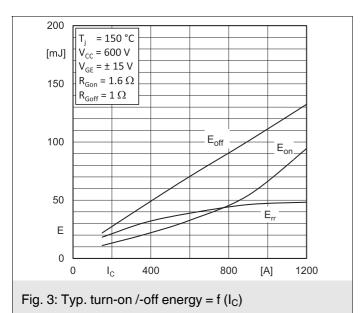
- Case temperature limited to T_c = 125°C max.
- Recommended T_{op} = -40 ... +150°C
- Product reliability results valid for $T_i = 150$ °C

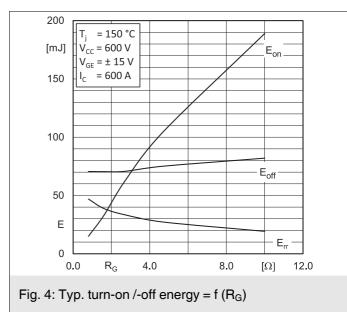
Characteristics										
Symbol	Conditions	min.	typ.	max.	Unit					
Inverse diode										
* F - * EC '	I _F = 600 A	T _j = 25 °C		2.28	2.63	٧				
	V _{GE} = 0 V chiplevel	T _j = 150 °C		2.28	2.61	V				
V _{F0}	chiplevel	T _j = 25 °C		1.30	1.50	V				
		T _j = 150 °C		0.90	1.10	V				
r _F	chiplevel	T _j = 25 °C		1.64	1.88	mΩ				
		T _j = 150 °C		2.3	2.5	mΩ				
I _{RRM}	$I_F = 600 \text{ A}$ $di/dt_{off} = 8700 \text{ A/}\mu\text{s}$ $V_{GE} = -15 \text{ V}$ $V_{CC} = 600 \text{ V}$	T _j = 150 °C		566		Α				
Q_{rr}		T _j = 150 °C		99		μC				
E _{rr}		T _j = 150 °C		40		mJ				
R _{th(j-c)}	per diode			0.095	K/W					
R _{th(c-s)}	per diode (λ _{grease} =0.81 W/(m*K))			0.039		K/W				
R _{th(c-s)}	per diode, pre-applied phase change material			0.028		K/W				
Module	•									
L _{CE}				15		nΗ				
R _{CC'+EE'}	measured per switch	T _C = 25 °C		0.55		mΩ				
		T _C = 125 °C		0.85		mΩ				
R _{th(c-s)1}	calculated without thermal coupling			0.00879		K/W				
R _{th(c-s)2}	including thermal coupling, Ts underneath module $(\lambda_{grease}=0.81 \text{ W/(m*K)})$			0.014		K/W				
R _{th(c-s)2}	including thermal coupling, Ts underneath module, pre-applied phase change material			0.008		K/W				
Ms	to heat sink M6		3		5	Nm				
Mt		to terminals M6	2.5		5	Nm				
						Nm				
w					325	g				

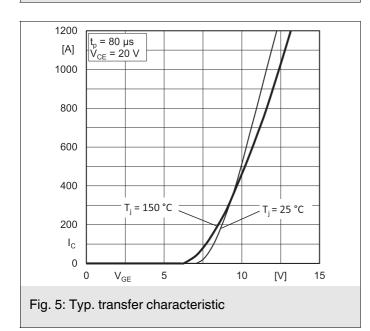


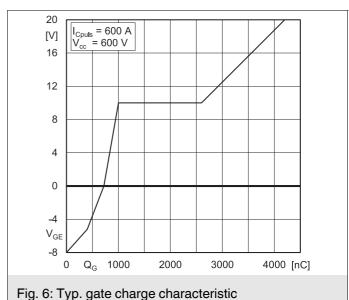


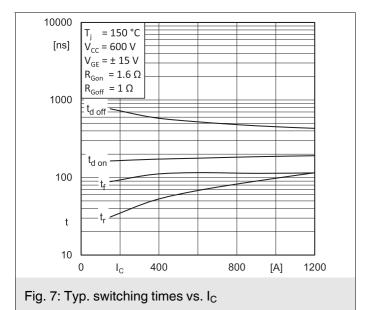


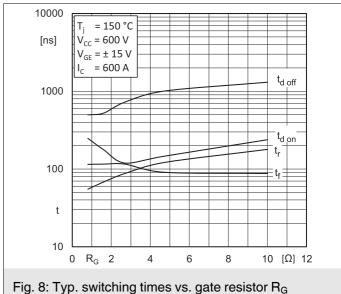


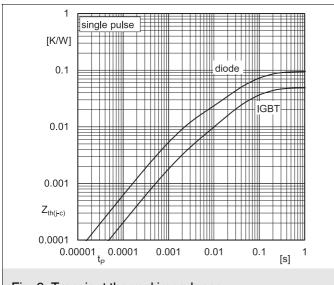


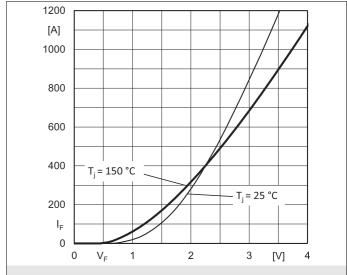












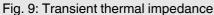
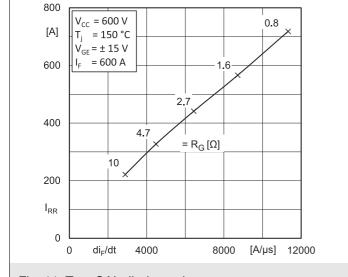


Fig. 10: Typ. CAL diode forward charact., incl. $R_{CC'+EE'}$



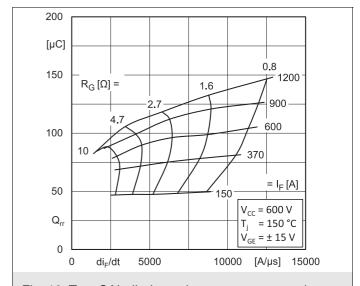
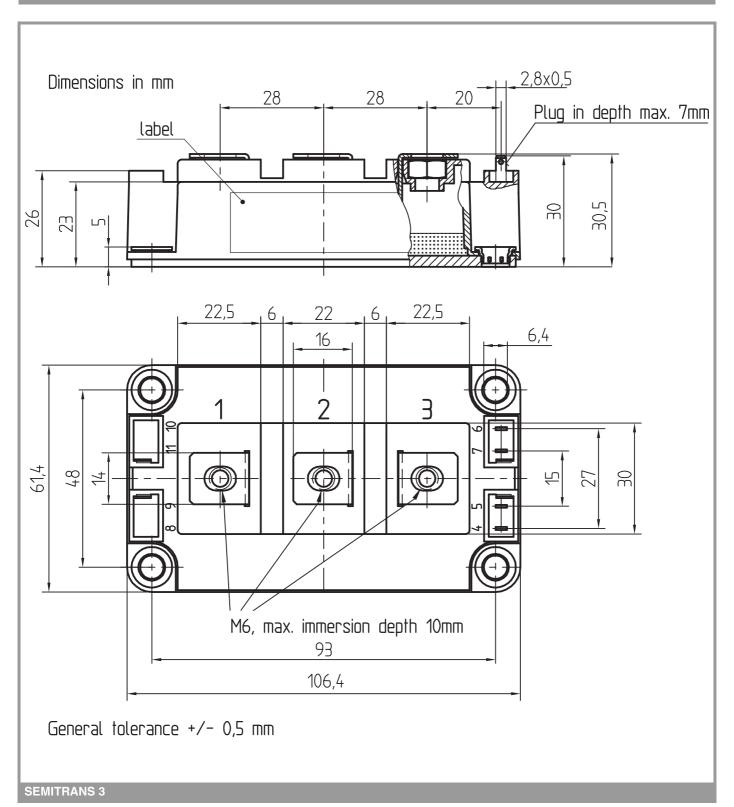
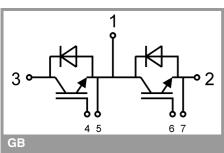


Fig. 11: Typ. CAL diode peak reverse recovery current

Fig. 12: Typ. CAL diode peak reverse recovery charge





This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, chapter IX.

*IMPORTANT INFORMATION AND WARNINGS

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